### **Characteristics** 1

Table 1.	Absolute ratings	(limiting values)
	Aboolate ratingo	(mining values)

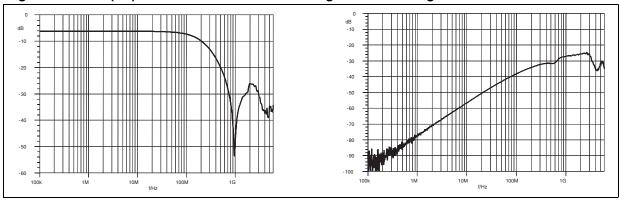
Symbol	Parameter and test conditions	Value	Unit
Тj	Maximum junction temperature	125	°C
T <sub>op</sub>	Operating temperature range	- 40 to + 85	°C
T <sub>stg</sub>	Storage temperature range	- 55 to + 150	°C

### Table 2.

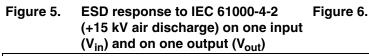
## Electrical characteristics (T<sub>amb</sub> = 25 °C)

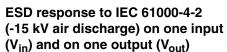
Symbol	Parameter		<b>^</b>		
V <sub>BR</sub>	Breakdown voltage				
I <sub>RM</sub>	Leakage current @ V <sub>RM</sub>	VBR VRM IRM		- V	
V <sub>RM</sub>	Stand-off voltage				
R	Series resistance between input and output	ıt /			
C <sub>line</sub>	Input capacitance per line				
Symbol	Test conditions	Min.	Тур.	Max.	Unit
V <sub>BR</sub>	I <sub>R</sub> = 1 mA	6	8	10	V
I <sub>RM</sub>	V <sub>RM</sub> = 3 V per line			500	nA
R	I = 10 mA	80	100	120	Ω
C <sub>line</sub>	$V_R = 3 V dc, 1 MHz V_{OSC} = 30 mV$		16	19	pF





### Figure 3. S21 (dB) attenuation measurement Figure 4. Analog crosstalk measurement





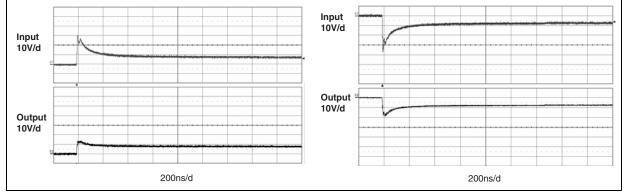
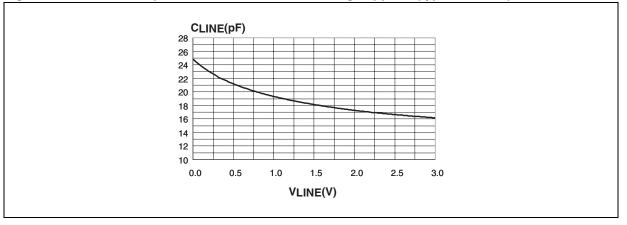
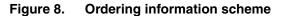


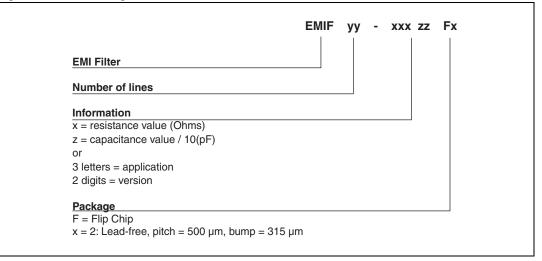
Figure 7. Junction capacitance versus reverse voltage applied (typical values)



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#### 2 **Ordering information scheme**





#### Package information 3

In order to meet environmental requirements, ST offers these devices in ECOPACK<sup>®</sup> packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at www.st.com.

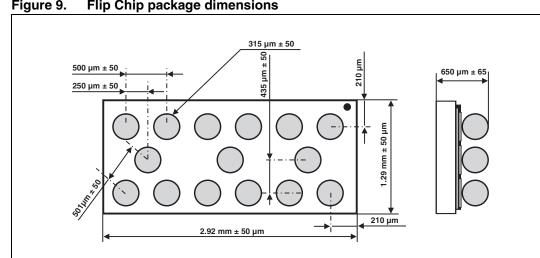
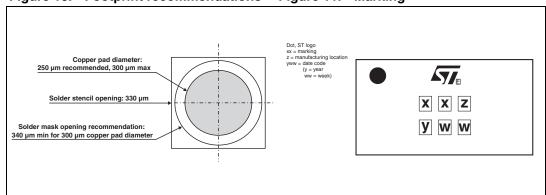
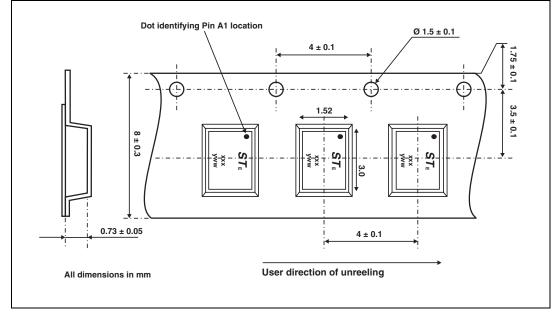


Figure 9. Flip Chip package dimensions









Note:More packing information is available in the application noteAN1235: "Flip Chip: Package description and recommendations for use"AN1751: "EMI Filters: Recommendations and measurements"



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# 4 Ordering information

## Table 3.Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
EMIF06-VID01F2	GR	Flip Chip	5.4 mg	5000	Tape and reel 7"

## 5 Revision history

## Table 4.Document revision history

Date	Revision	Changes
15-Feb-2005	1	First issue.
28-Apr-2008	2	Added ECOPACK statement. Updated <i>Figure 9</i> , <i>Figure 11</i> , and <i>Figure 12</i> . Reformatted to current standards.

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